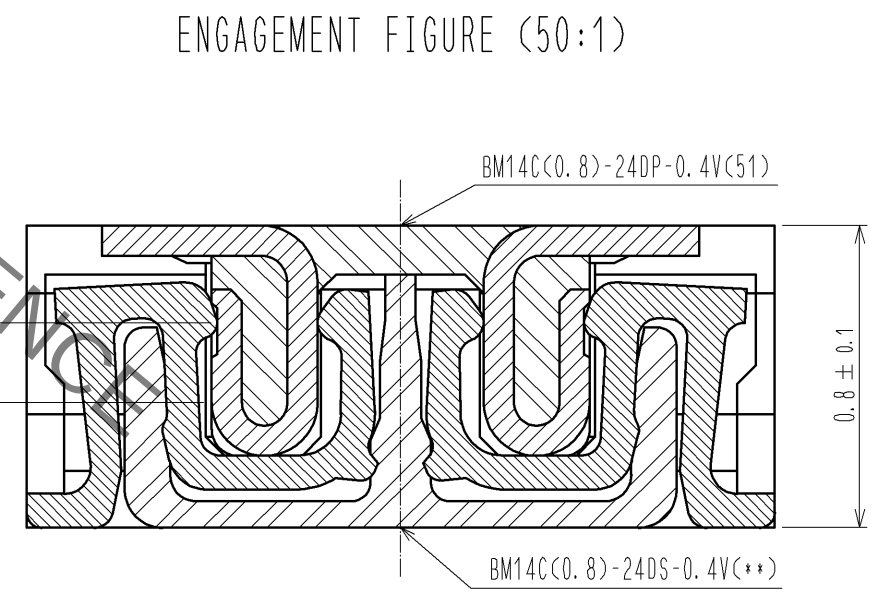
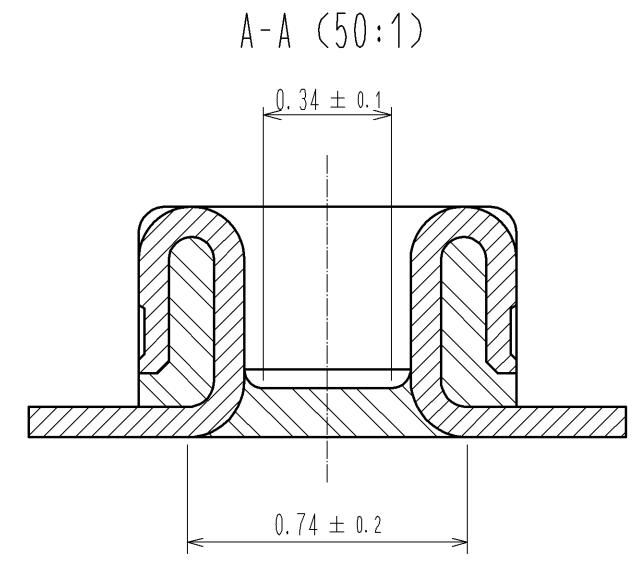
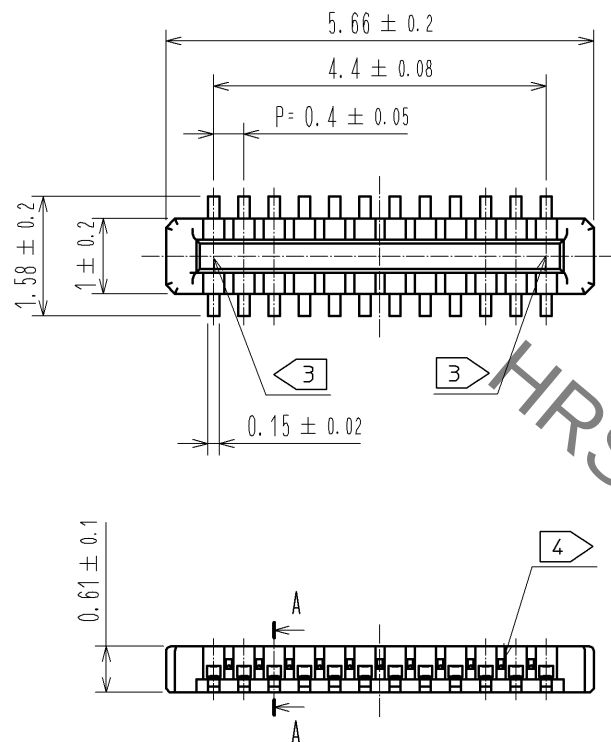


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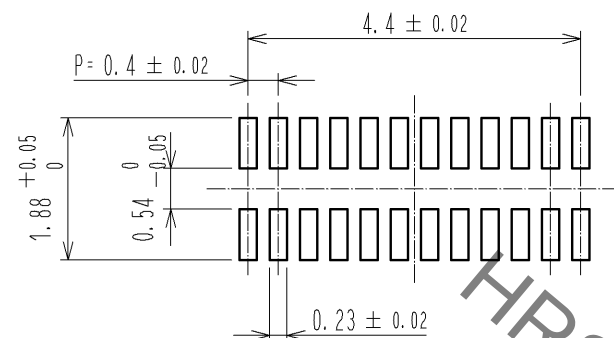


- NOTE) 1 . ALL LEAD CO-PLANARITY SHALL BE 0.08mm MAX
2 . CONTACT PLATING SPECIFICATIONS
CONTACT AREA : GOLD 0.05 μ m MIN
SMT LEAD : GOLD 0.05 μ m MIN
UNDERPLATING : NICKEL 1 μ m MIN
(SURFACE : SEALING)
3 . HRS MARK AND CAV No. ARE INDICATED IN APPROX POSITION SHOWN.
4 . A PART OF THE WALL COULD BE NOTCHED.

3	PS	CLEAR (ENBOSSED CARRIER TAPE)	6	PS	CLEAR (REINFORCEMENT COLLAR)
2	PHOSPHOR BRONZE	2	5	PS	BLACK (PLASTIC REEL)
1	LCP	UL94 V-0, BLACK	4	POLYESTER	CLEAR (COVER TAPE)
NO.	MATERIAL	FINISH , REMARKS	NO.	MATERIAL	FINISH , REMARKS
UNITS mm		SCALE 10 : 1	COUNT 2	DESCRIPTION OF REVISIONS DIS-H-005556	DESIGNED YN. SAKAMOTO
HIROSE ELECTRIC CO., LTD.		APPROVED : KH. IKEDA	10.12.25	DRAWING NO. EDC3-324416-01	DATE 11.02.25
		CHECKED : TS. MIYAZAKI	10.12.25	PART NO. BM14C<0.8>-24DP-0.4V(51)	
		DESIGNED : TR. YUNOKI	10.12.25	CODE NO. CL684-8026-0-51	
		DRAWN : YN. SAKAMOTO	10.12.24		

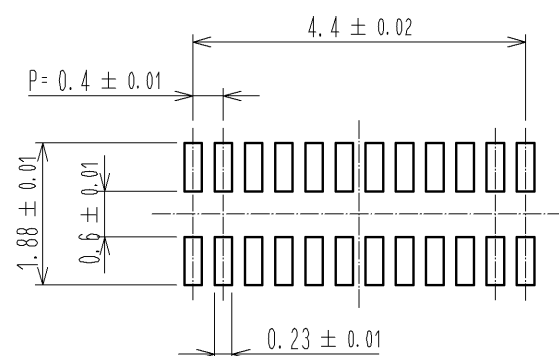
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◆ RECOMMENDED PCB LAYOUT

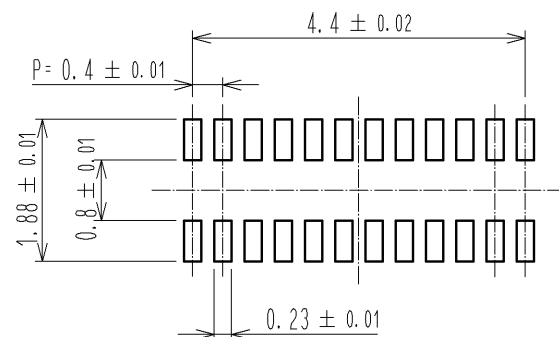


◆ RECOMMENDED METAL MASK DIMENSIONS

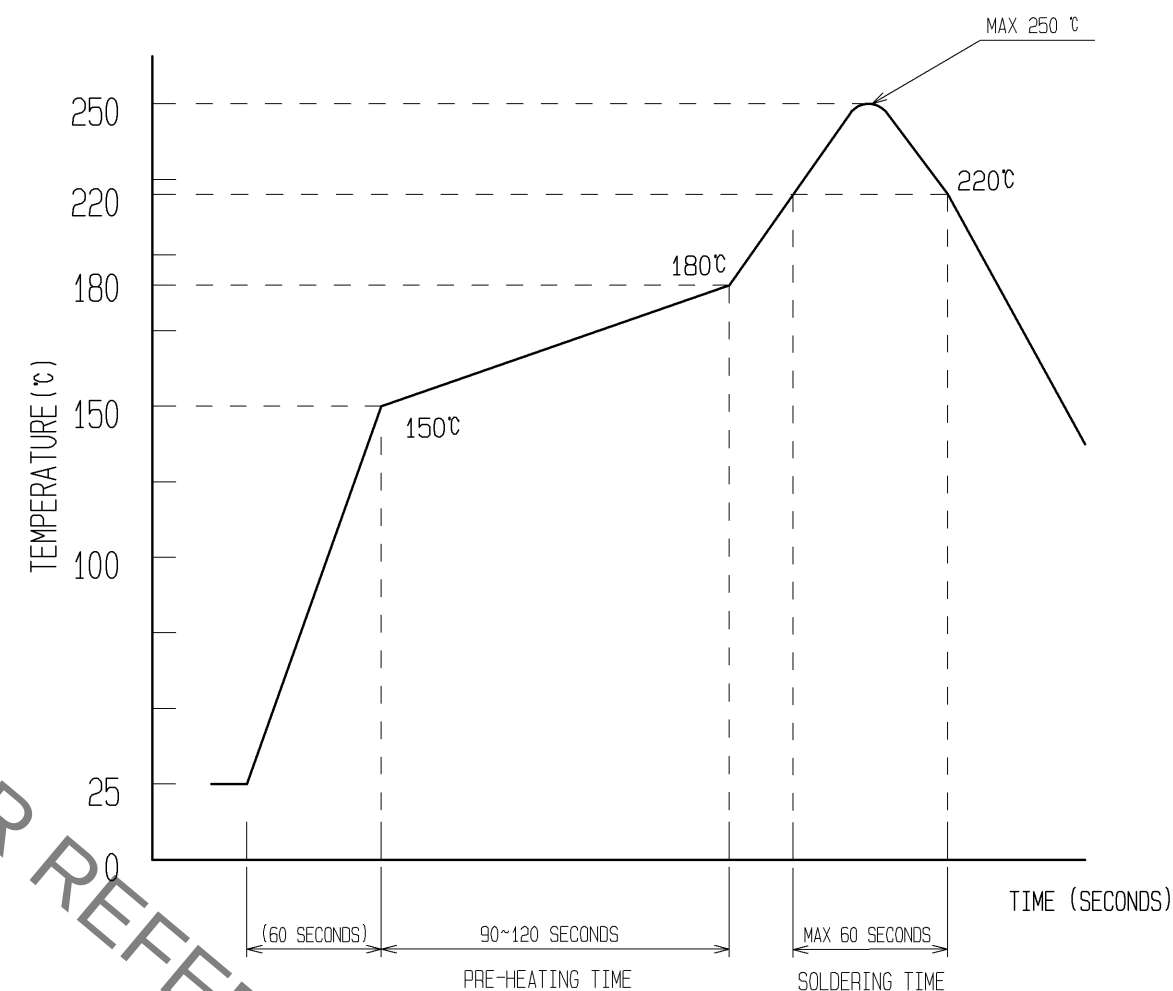
METAL MASK THICKNESS : $100 \mu\text{m}$



METAL MASK THICKNESS : $120 \mu\text{m}$



5 RECOMMENDED REFLOW TEMPERATURE PROFILE USING LEAD-FREE SOLDER PASTE.



REFLOW METHOD: IR REFLOW
NUMBER OF REFLOW CYCLES: 2 CYCLES MAX.

- 1) REFLOW TIME
DURATION ABOVE 220 $^{\circ}\text{C}$, 60 SEC. MAX.
(PEAK TEMPERATURE: 250 $^{\circ}\text{C}$ MAX)
- 2) PRE-HEAT TIME
PRE-HEAT TEMPERATURE(MIN): 150 $^{\circ}\text{C}$
PRE-HEAT TEMPERATURE(MAX): 180 $^{\circ}\text{C}$
PRE-HEAT TIME: 90-120 sec.

5 THIS TEMPERATURE PROFILE IS PER THE CONDITIONS SHOWN ABOVE. ADDITIONAL FACTORS, SUCH AS SOLDER PASTE TYPE, PCB SIZE AND OTHER MOUNTED COMPONENTS COULD AFFECT THE PROFILE, THEREFORE, A THOROUGH EVALUATION OF MOUNTING CONDITION IS REQUIRED PRIOR TO PRODUCTION. TEMPERATURE IS MEASURED AT CONTACT LEAD.

HRS

DRAWING NO.	EDC3-324416-01
PART NO.	BM14C(0.8)-24DP-0.4V(51)
CODE NO.	CL684-8026-0-51

1/2/3

8

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